

How to use PWM shutdown for motor control and digital power conversion on STM32 MCUs

Introduction

The purpose of this application note is to describe the STM32 device timer break feature. It details its use with other STM32 internal resources for an overcurrent and overvoltage protection. Namely, in applications related to the motor control and the digital power conversion such as lighting, SMPS, and induction heating.

This application note:

- provides an overview of the timer break feature.
- details how the timer break input is connected to different break sources.
- · enumerates the different break event sources.
- provides some scenarios of the PWM output signal response to break events coming from an internal source, an external source, or a combination of both internal and external break signals.
- shows how to implement overcurrent and overvoltage protections using the timer break feature and other embedded peripherals such as comparators and DAC.

This document applies to the products listed in Table 1.

Table 1. Applicable products

Type	Product series
Microcontrollers	 STM32C0 series STM32F0 series, STM32F1 series, STM32F2 series, STM32F3 series, STM32F4 series, STM32F7 series STM32G0 series, STM32G4 series STM32H5 series, STM32H7 series STM32L4 series, STM32L5 series STM32U0 series, STM32U5 series STM32WB series, STM32WL series



1 General information

This document applies to Arm[®]-based devices.

Note: Arm is a registered trademark of Arm Limited (or its subsidiaries) in the US and/or elsewhere.

arm

Reference documents

[1] Application note STM32 cross-series timer overview (AN4013)

AN4277 - Rev 7 page 2/26



2 Break function overview

The break function is available in TIM1, TIM8, TIM20, TIM15, TIM16, and TIM17 timers. These timers are able to generate complementary PWM signals with a dead time insertion for driving power switches in a half-bridge topology.

The purpose of the break function is to protect power switches driven by PWM signals generated with these timers. When triggered by a fault, the break circuitry shuts down the PWM outputs and forces them to a predefined safe state.

Table 2 summarizes the break inputs availability.

Table 2. Timers and break input availability in STM32 devices

-	TIM1	TIM8	TIM20	TIM15	TIM16	TIM17	
07140050	BRK						
STM32F0	BRK_ACTH	-	-	-	-	-	
07110074	BRK			BRK	BRK	BRK	
STM32F1	BRK_ACTH	-	-	BRK_ACTH	BRK_ACTH	BRK_ACTH	
STM32F2	BRK	BRK					
STM32F4	BRK_ACTH	BRK_ACTH	-	-	-	-	
	BRK	BRK	BRK	BRK	BRK	BRK	
STM32F3	BRK2	BRK2	BRK2	BRK_ACTH	BRK_ACTH	BRK_ACTH	
	BRK_ACTH	BRK_ACTH	BRK_ACTH	-	-	-	
	BRK	BRK					
STM32F7	BRK2	BRK2	_	-	_	-	
	BRK_ACTH	BRK_ACTH					
STM32L4	BRK	BRK		BRK	BRK	BRK	
STM32L5 STM32U5	BRK2	BRK2	_	System break	System break	System break	
STM32H7 ⁽¹⁾ STM32H5 ⁽²⁾	System break	System break		-	-	-	
STM32C0	BRK				BRK	BRK	
STM32WB	BRK2	-	-	-	System break	System break	
STM32WL	System break				-	-	
	BRK			BRK	BRK	BRK	
STM32G0	BRK2	-	-	System break	System break	System break	
	System break			-	-	-	
	BRK	BRK	BRK	BRK	BRK	BRK	
STM32G4	BRK2	BRK2	BRK2	System break	System break	System break	
	System break	System break	System break	-	-	-	
	BRK						
STM32H503 STM32U0	BRK2	-	-	-	-	-	
	System break						
	BRK						
STM32L0	-	-	-	-	-	-	
	-						

^{1.} Some STM32H7 devices do not feature TIM8, refer to the product datasheet for details.

AN4277 - Rev 7 page 3/26

^{2.} Excluding STM32H503.



The BRK input can either disable the PWM outputs (inactive state) or force them to a predefined safe state, either active or inactive, after a dead time insertion. This prevents any shoot-through in the half bridge. The BRK2 only disables the PWM outputs (inactive state).

BRK has a higher priority than BRK2. When both protections are triggered, the predefined safe state related to the BRK circuitry overrides the inactive state related to the BRK2 input.

Typically, a permanent magnet 3-phase brushless motor drive uses the protections as follows:

- The BRK2 input as an overcurrent protection, opening the six switches from the power stage.
- The BRK input as an overvoltage protection, overriding the overcurrent and closing the three low-side switches to avoid current regeneration to build up the bus voltage and exceed the capacitor-rated voltage.

As an example in STM32F303xB/C/D/E devices, for a dual motor drive, the comparators 1, 2, and 3 can be dedicated to overcurrent monitoring of the three phases of motor 1 (BRK2 input of TIM1). The comparators 4, 5, and 6 can be dedicated to overcurrent monitoring of the three phases of motor 2 (BRK2 input of TIM8), while the comparator 7 is used for overvoltage monitoring (driving BRK inputs of TIM1 and TIM8).

BRK_ACTH input is connected only to internal signals such as CSS and PVD output. On newer devices like STM32U5 it is marked as tim_sys_brk (system break interconnect) or as *internal source* but this serves the same purpose. For more details, refer to Section 3: Break implementation.

The availability of break inputs and the break sources depends on the selected STM32 family.

Table 3. Comparator peripherals availability per STM32 device

This is summarized in Table 3 and in document [1] which details the available timers.

Comparator availability may be limited by the package pin count.

Comparate		STM32F0						s	τM	32F	3							Contro	S MI32L4								STM32G0 ⁽³⁾		CTMTS	9 MI32G4	STM32H5	
	STM32F05xxx	STM32F07xxx	STM3209xxx	STM32F303xB/C	STM32F358xC	STM32F303x6/8	STM32F328x8	STM32F303xD/E	STM32F398xE	STM32F302xB/C/D/E	STM32F302x6/8	STM32F301x6/8	STM32F318x8	STM32F334x4/6/8	STM32F37xxx	STM32L1 ⁽¹⁾	STM32L0 ⁽²⁾	STM32L4	STM32L4+	STM32L5	STM32U5	STM32WB	STM32WL	STM32110	70710	STM32G051/61	STM32G071/81	STM32G0B1/C	STM32G4x1	STM32G4x3	STM32H503	STM32H7
Filter		-			-		-		-	-		-		-	-		-	DFS	SDM	DFSDM	MDF ⁽⁴⁾			-				-	-	-	-	DFSDM ⁽⁵⁾
COMP 1		Х		>	Κ		-)	X	Х		-		-	Х)	K	2	X	X	Х			X	(Х	Х	Х	Х	Х
COMP 2		Х)	K)	K)	X	Х		Χ		Х	Х)	K	X	(6)	X	Х			X	(Х	Х	Х	-	X
COMP 3		-)	<		-)	X	-		-		-	-		-		-	-	-			-				Х	Х	Х	-	-
COMP 4		-		>	<)	K		X	Х		X		Х	-		-		-	-	-			-				-	Х	Х	-	-
COMP 5		-		>	Κ		-)	X	-		-		-	-		-		-	_	-			-				-	-	Х	-	-
COMP 6		-)	Κ)	K)	X	Х		X		Х	-		-		-	-	-			-				-	-	Х	-	-
COMP 7		-		>	K		-)	X	-		-		-	-		-		-	-	-			-				-	-	X	-	-

- 1. These devices feature comparators, but no advanced timers with break inputs.
- 2. These devices feature comparators, but no advanced timers with break inputs. STM32L010 value line has no comparators either.
- 3. STM32G0x0, STM32G031, and STM32G041 have no comparators.
- 4. ADF does not feature a break output.
- 5. STM32H7Rx/Sx only implement ADF, which does not feature a break output.
- 6. STML412/L422 does not have COMP2.

AN4277 - Rev 7 page 4/26



Break implementation

3.1 TIM1/8/20 break implementation

The source for break BRK channel is an external source connected to one of the BKIN pins (as per selection done in the AFIO controller), with polarity selection and optional digital filtering.

The source of break2 BRK2 channel is an external source connected to one of the BKIN2 pins (as per selection done in the AFIO controller), with polarity selection and optional digital filtering.

The source for BRK ACTH (or system break interconnect) is an internal signal coming from:

- The comparator output (on STM32Fx)
- The clock security system
- The lockup of Cortex-M family CPUs
- The PVD output
- The SRAM ECC/parity error signal
- The flash ECC error

BRK

- In all series, the input signal on BRK is connected to the BKIN pin.
- In the STM32F3 series, the input signal on BRK is a logical OR between the input signals on the BKIN pin and the used comparator (4 or 7) output if configured and used internally. If the BKIN alternate function is disabled, the resulting break signal is the comparator (4 or 7) output.
- In the STM32L4 and STM32H7 series, the input signal on BRK is a logical OR between the input signals on the BKIN pin, the used comparator (1 or 2) output, and the DFSDM break output if configured and used internally. Each application break source has its own polarity configuration.
- In the STM32U5 series, the input signal on BRK is a logical OR between the comparators (including MDF) break outputs and external sources.

The polarity feature is available for the BRK input. The filter feature is available as well but only on STM32F3/F7/L4/U5 devices.

BRK_ACTH (or system break)

- In the STM32F1/F2/F4/F7 series, this input only gathers the system level fault signals.
- In the STM32F0 series, BRK_ACTH is connected to the system level fault signals and the comparators outputs (1 and 2).
- In the STM32F3 series, BRK_ACTH is connected to the system level fault signals and the comparators (1, 2, 3, 5, and 6).
- For any non-Fx series, the system break request is connected to the system level fault signals.

When this input is used, the polarity selection and filter features are not available. It is always active high.

BRK ACTH is enabled using the same bit as BRK (BKE in TIMx BDTR, x= 1, 8, 20).

If there are several system break input sources, the resulting input signal is an OR between all the input signals. Except for the CSS fault signal, the inputs can be individually disabled using the system control block registers.

Other break inputs, external, filter, or comparator are also ORed together and then with the system break inputs. In case of comparator and external signals, polarity must be observed for the logical OR to work as intended.

BRK2

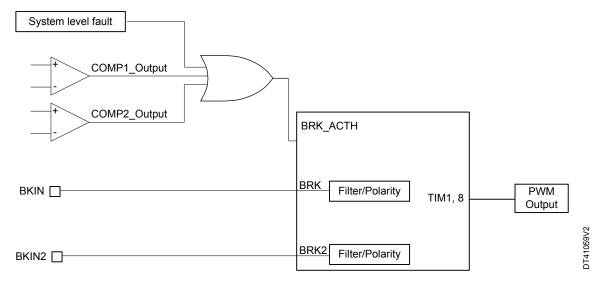
- In the STM32F3 series, this input signal is a logical OR between the input signal on the BKIN2 pin and the used comparators outputs (1, 2, 3, 4, 5, 6, and 7). If the BKIN2 alternate function is disabled (input not used), the resulting break signal is solely related to the comparators.
- In the STM32F7 series, the input signal on BRK2 is connected to the BKIN2 pin.
- In the STM32L4 series, the input signal on BRK2 is a logical OR between the input signals on the BKIN2 pin, the used comparator (1 or 2) output and the DFSDM break output if configured.
- In the STM32U5 series, the input signal on BRK2 is a logical OR between comparators (1 or 2) and MDF1.

AN4277 - Rev 7 page 5/26



- In the STM32L4 and STM32L5 series, it is possible to configure the polarity of each break source in addition except the DFSDM break output to the polarity configuration inside the timer peripheral using BKCMP1P, BKCMP2P, BKINP in TIMx_OR2 register and BK2CMP1P, BK2CMP2P, BK2INP in TIMx_OR3 register.
- In the STM32U5 and STM32H7 series, it is possible to configure the polarity of each break source in addition except the MDF1 (DFSDM) break output to the polarity configuration inside the timer peripheral using BKCMP1P, BKCMP2P, BKINP in the TIMx_AF1 register and BK2CMP1P, BK2CMP2P, BK2INP in the TIMx AF2 register.
- In the STM32G4 series, it is possible to configure the polarity of COMP1-4 using BKCMPxPbits in TIMx_AF1 register and BK2CMPxP in TIMx_AF2 register. The rest of the internal inputs have individual polarity fixed to active high, though the collective polarity is still configurable (BKP, BK2P).
- On other series, polarity is individually configurable for all their available COMPx and BKIN/BKIN2 inputs.
- Figure 1 shows the break feature implementation for TIM1 and TIM8 in STM32F0/F1/F2/F4/F7 series devices.
- Figure 2 shows the break feature implementation for TIM1, TIM8, and TIM20 in STM32F3 series devices.
- Figure 3 shows the break feature implementation for TIM1 and TIM8 in STM32L4 series devices.
- Figure 4 shows the break feature implementation for TIM1 and TIM8 in STM32U5 series devices.

Figure 1. Break feature implementation in advanced timers for STM32F0/F1/F2/F4/F7 series devices



AN4277 - Rev 7 page 6/26



COMP1_Output COMP2_Output COMP3_Output COMP5_Output COMP6_Output PVD output CSS clock failure event SRAM parity error signal Cortex-M4 LOCKUP output BRK_ACTH BKIN 🔲 COMP4_Output PWM Output Filter/Polarity TIM1, 8, 20 COMP7_Output BRK2 Filter/Polarity BKIN2 COMP1_Output DT41060V2 COMP7_Output

Figure 2. Break feature implementation in advanced timers for STM32F3 series devices

AN4277 - Rev 7 ______ page 7/26



Figure 3. Break feature implementation in advanced timers for STM32L4 series devices

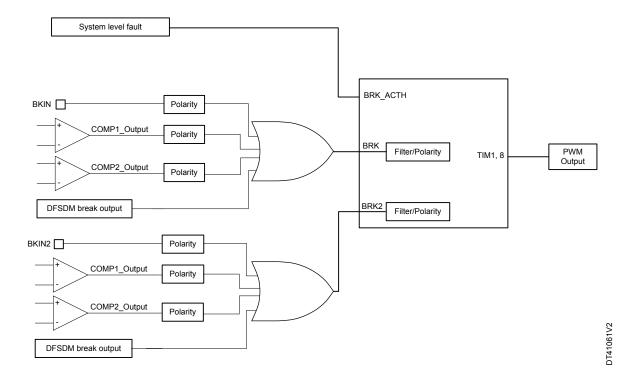
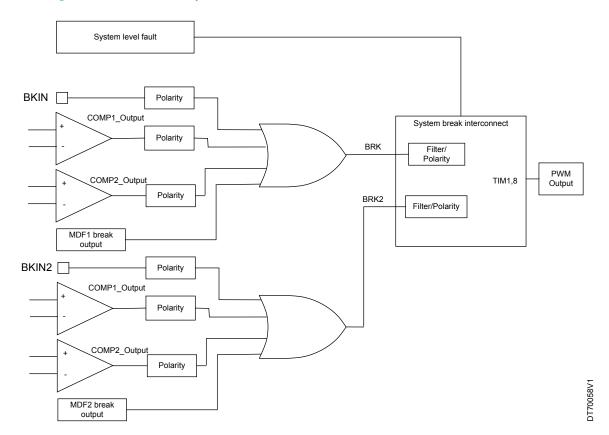


Figure 4. Break feature implementation in advanced timers for STM32U5 series devices



AN4277 - Rev 7 page 8/26



Bidirectional break inputs

For example in the STM32L4 and STM32U5 series, the timer 1 and timer 8 are featuring bidirectional break input/ outputs combining the comparator output (to be configured in open drain) and the Timer BKIN input, as represented in Figure 5.

This feature allows information about the global break available for external MCUs with a single-pin.

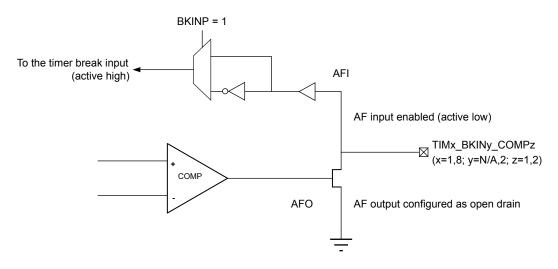


Figure 5. Output redirection

3.2 TIM15/16/17 break implementation

The source for break BRK channel is an external source connected to one of the BKIN pins (as per selection done in the AFIO controller), with polarity selection and optional digital filtering.

The source for BRK_ACTH is an internal signal coming from:

- The clock security system
- The lockup of Cortex-M family CPUs
- The PVD output
- The SRAM ECC/parity error signal
- The flash ECC error

Inputs from available comparators are ORed with BRK_ACTH signals (on STM32Fx series) or with the external BRK input with polarity selection option.

BRK

- In all series: the input signal on BRK is connected to the BKIN pin.
- In the STM32L4 series: the input signal on BRK is a logical OR between the input signals on the BKIN pin, the used comparator (1 or 2) output and the DFSDM break output if configured.
- In STM32U5 series: the input signal on BRK is a logical OR between the BKIN pin, the used comparator (1 or 2) output, and the MDF1 break output.

The polarity selection feature is available for the BRK source.

In STM32L4 series, it is possible to configure the polarity of each break source in addition except the DFSDM break output to the polarity configuration inside the timer peripheral using BKCMP1P, BKCMP2P, BKINP in the TIMx OR2 register.

In STM32U5 series, it is possible to configure the polarity of each break source in addition. Thus, except the MDF1 break output to the polarity configuration inside the timer peripheral. This is done using BKCMP1P, BKCMP2P, BKINP in the TIMx_AF1 register.

Note: On TIM15-17, the filter feature is only available for STM32Gx, STM32Hx, and STM32U5 devices.

AN4277 - Rev 7 page 9/26

DT35330V2



BRK_ACTH (or system break)

- In STM32F1/L4 series, this input only gathers the system level fault signals (CSS, PVD output, SRAM parity error, and the Hardfault).
- In STM32F3 series, BRK_ACTH is connected to the system level fault signals and the comparators (1 and 2) for the STM32F37xxx devices and the comparators outputs (3, 5, and 7) for the rest of the STM32F3 series.
- In other series, system break interconnected sources are CSS, flash, and SRAM ECC errors, PVD and core lockup detection.

When this input is used, the polarity selection and filter features are not available. It is always active high. BRK_ACTH is enabled using the same bit BRK (BKE in TIMx_BDTR, x= 15, 16, 17).

When using BRK_ACTH as break input, the polarity must be configured high. Otherwise, there is no PWM generation independently of the break signal coming from the internal source.

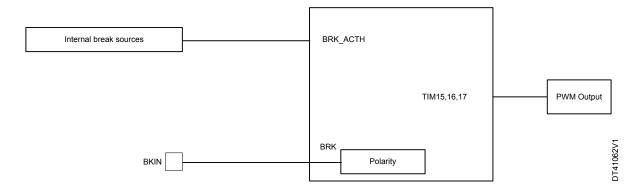
Figure 6 shows the break feature implementation for TIM15, TIM16, and TIM17 in STM32F1 series devices.

Figure 7 shows the break feature implementation for TIM15, TIM16, and TIM17 in STM32F3 series devices.

Figure 8 shows the break feature implementation for TIM15, TIM16, and TIM17 in STM32L4 series devices.

Figure 9 shows the break feature implementation for TIM15, TIM16, and TIM17 in STM32U5 series devices.

Figure 6. Break feature implementation for TIM15, TIM16, and TIM17 for STM32F1 series devices



AN4277 - Rev 7 page 10/26



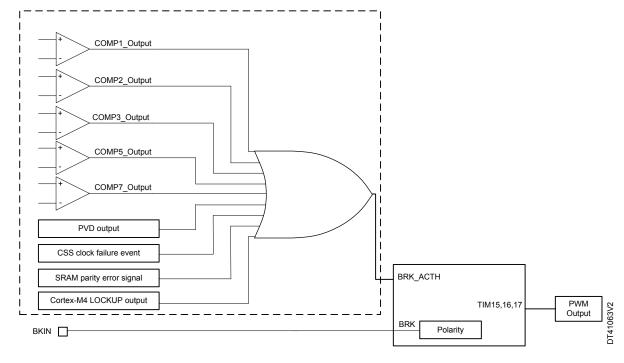
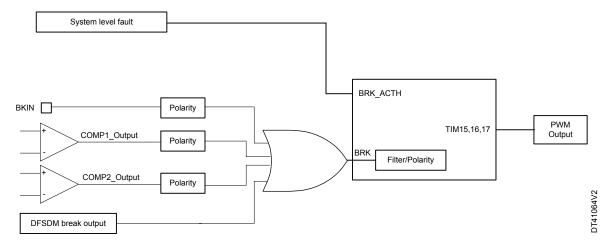


Figure 7. Break feature implementation for TIM15, TIM16, and TIM17 for STM32F3 series devices

Figure 8. Break feature implementation for TIM15, TIM16, and TIM17 for STM32L4 and STM32H7 series devices

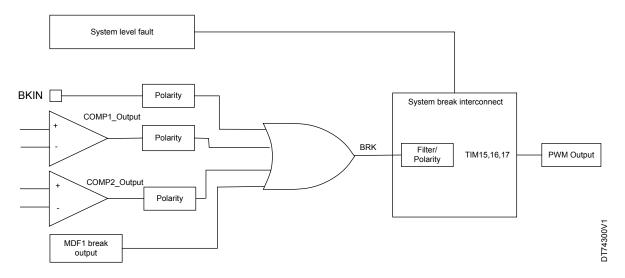


- If only an internal break source is used, the polarity must be configured to high in the software.
- If there are several break input sources, the resulting input signal is an OR between all the input signals.
- If both internal break source and BKIN are used, the resulting break signal is an OR between the signal pin and the internal break signal.
- If the alternate function AF of the BKIN or BKIN2 pin is not activated, the BRK or the BRK2 is connected to the ground. If the state of the BRK or BRK2 polarity is low, in this case if the break function is enabled, the timer output is disabled. Thus, it must configure the break polarity to high. Only in the STM32F1 series it must configure the break polarity to low.

AN4277 - Rev 7 page 11/26



Figure 9. Break feature implementation for TIM15, TIM16, and TIM17 in STM32U5 series devices



Note: STM32G0, STM32H7, STM32WB, and STM32WL are similar to STM32U5, except for MDF.

AN4277 - Rev 7 page 12/26



4 Break sources summary

Table 4 summarizes the available break sources and their connections externally or internally to timers (1, 8, 20, 15, 16, and 17) break inputs.

Table 4. Break input sources

-	BRK	BRK_ACTH (or system break)	BRK2
External connection to pin	BKIN	No corresponding I/O	BKIN2
Internal connection to pin	In STM32F3: Comparators 4 and 7 for TIM1/8/20 NA for TIM15/16/17 In STM32L4 and STM32H7: Comparators 1 and 2 DFSDM break output In STM32U5: Comparators 1 and 2 MDF1 break output	Available signals from: Clock failure event generated by CSS PVD output RAM parity error signal Cortex-M4 LOCKUP output (Hardfault) Comparator outputs (on STM32Fx series)	In STM32F3: Comparators 1, 2, 3, 4, 5, 6, and 7 In STM32L4 and STM32H7: Comparators 1 and 2 DFSDM break output In STM32U5: Comparators 1 and 2 MDF1 break output
Polarity feature in case of internal connection	Configurable for most inputs: active high or active low	Always active high	Configurable for some inputs: active high or active low
Polarity feature in case of external break event	Available	NA	Available
Filter feature	Not available in STM32F0, STM32F1, STM32F2, and STM32F4. Only available in STM32F3 advanced timers.	NA	Not available in STM32F0, STM32F1, STM32F2, and STM32F4
Available in	TIM1/8/20/15/16/17	TIM1/8/20/15/16/17	TIM1/8/20 in STM32F3, TIM1/8 in other series
Resulting break signal in case of parallel external or/and internal break sources	It is an OR betwee	en the external break signals and	d the internal ones.

AN4277 - Rev 7 ______ page 13/26



5 Examples

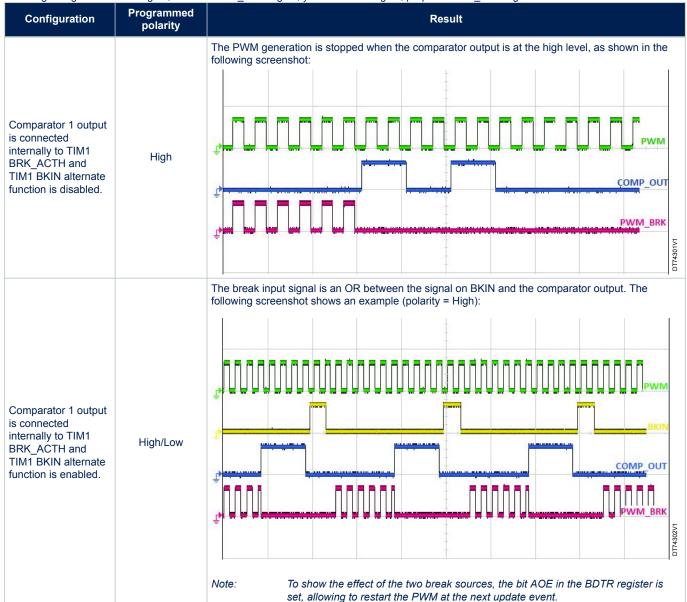
Table 5 shows the PWM output status for TIMx (where x = 1, 8, 20, 15, 16, 17) in response to internal/external break events.

In the following waveforms:

- The PWM signal is the reference waveform (internal signal, before BRK protection).
- The COMP_OUT signal represents the BRK input signal, in our case it is the comparator output.
- The BIN signal is the input signal on BKIN.
- The PWM BRK signal is the resulting PWM signal on the timer output after break detection.

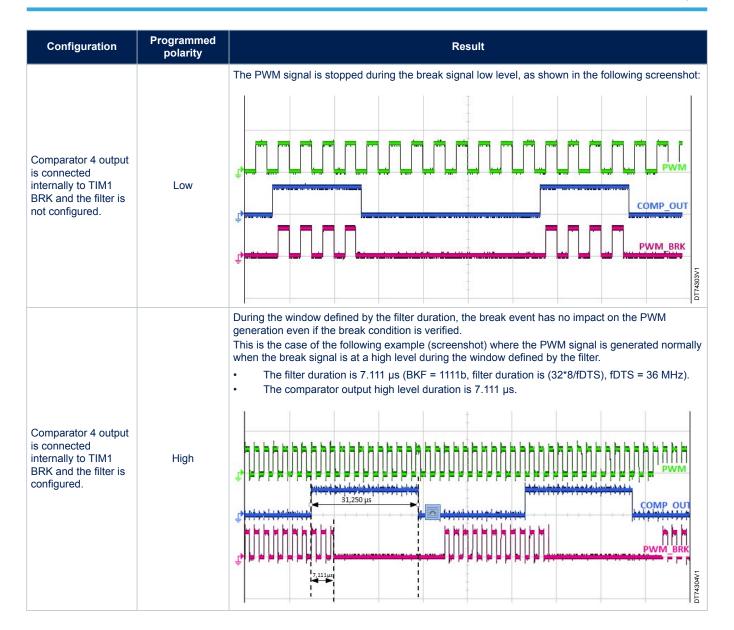
Table 5. Scenarios of PWM output status in response to internal/external break events

Color legend: green = PWM signal, blue = COMP_OUT signal, yellow = BKIN signal, purple = PWM_BRK signal.



AN4277 - Rev 7 page 14/26





AN4277 - Rev 7 page 15/26



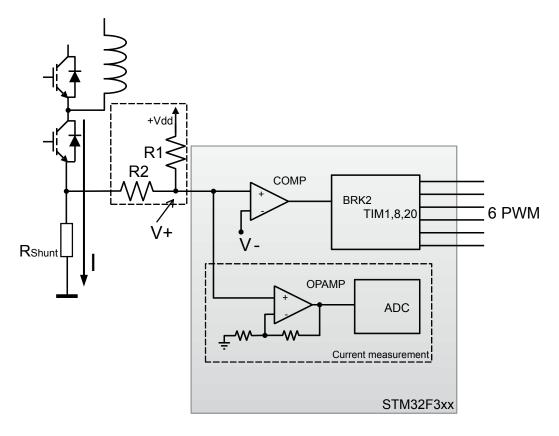
6 Using the break function with other MCU resources

This section focuses on the STM32F3 series, but some parts may also apply to other STM32 series, especially the STM32G4. In some cases, analogous resources may be used, such as system level fault instead of BRK ACTH.

6.1 Break function used for overcurrent protection

The STM32F3 series microcontroller embeds a set of peripherals designed to resolve common motor control issues by reducing the number of required external components. This section describes how to use these peripherals to implement overcurrent protection. Figure 10 shows the overcurrent protection network that can be implemented using the internal resources of the STM32F3 series.

Figure 10. Overcurrent protection network implemented with STM32F3 series devices



The principle of this overcurrent protection mechanism can be summarized as follows:

- The phase current of the motor flows in the power transistor of the inverter bridge and passes through the shunt resistor (R_{Shunt}) producing a voltage drop (V+).
- This voltage drop is compared with a threshold (V-) defining the maximum admissible current.
- If the threshold is exceeded, a break signal stops the PWM generation putting the system in a safe state.

All of these actions can be performed using the internal resources of the STM32F3 series and, in particular, the embedded comparators and advanced timer break function (BRK2). In the basic implementation, the only external component required is the shunt resistor that must be sized depending on the current to be monitored and the shunt resistor power rating.

The two dotted line boxes in Figure 10 show the components required to measure current:

- The R1/R2 resistive network to add an offset necessary to measure AC currents.
- An operational amplifier with a built-in gain setting network.

The amplification network can be implemented externally for specific use cases where the built-in gain settings are not adequate.

AN4277 - Rev 7 page 16/26

DT31664V2

DT31666V2



6.2 Break function used for overvoltage protection

Figure 11 shows the overvoltage protection network that can be implemented using the internal resources of the STM32F3 series.

BUS voltage

COMP

BRK

TIM1,8,20

6 PWM

ADC

Bus voltage measurement

STM32F3xx

Figure 11. Overvoltage protection network implemented with STM32F3 series devices

In this case, the principle is similar to the one described in Section 6.1:

- A resistive voltage divider provides a signal proportional to the bus voltage.
- This reading is compared to an overvoltage threshold to generate a fault signal. See also: Appendix A.1: How to use the DAC to define thresholds.
- If the threshold is exceeded, a break signal stops the PWM generation putting the system in a safe state.

As mentioned before, these actions can be performed automatically using the internal comparator of the STM32F3 series. In this case, it is possible to use the second break functionality (BRK) of the advanced timer to differentiate the action to perform on the PWM signals in case of an overcurrent.

In the basic implementation, the only external component required is the voltage divider, which must be sized depending on the bus voltage range requested by the target application, so that it never exceeds the MCU's input maximum admissible voltage level.

The dotted line box in Figure 11 shows the components required for the bus voltage measurement. In this case, amplifying the signal V+ is usually not required (the resistive divider is adjusted for full-range reading), so this signal is fed directly to the analog-to-digital converter.

6.3 Using an external emergency signal together with the internal comparator

Commonly in MC applications, gate driver ICs, such as ST's L639x family or intelligent power modules (IPMs) - such as ST's SLLIMM (small low-loss intelligent molded module) family - have integrated comparators that can protect the inverter (ST's smart shutdown function) while sending an error signal to the microcontroller.

This section shows the possibility to combine these two concepts, as shown in , as to enhance by redundancy the functional safety offered by the "break function".

A first option is when the break function is triggered by internal comparators output only: the error signal coming from ICs or IPMs must not be connected to the microcontroller, thus saving the pin. The configuration to set in this case is summarized in the following table.

AN4277 - Rev 7 page 17/26



Description	Register	Bit	Configuration ⁽¹⁾
TIM1/8/20 BRK_ACTH/BRK/ BRK2 polarity	TIMx_BDTR	BKP or BK2P	1 (active high)
Comparator output polarity	COMPx_CSR	COMPxPOL	0 (not inverted), comparators input connected as shown in previous sections
TIM1/8/20 BKIN and BKIN2 AF	GPIOxAFRL or GPIOxAFRH	-	AF is not enabled on BKIN1/2 related pins
TIM1/8/20 BRK and BRK2 enable	TIMX_BDTR	BKE or BK2E	1
COMPx out selection	COMPx_CSR	COMPXOUTSEL	0001: TIM1 BRK or TIM1 BRK_ACTH ⁽²⁾ 0010: TIM1 BRK2 0011: TIM8 BRK or TIM8 BRK_ACTH ⁽³⁾ 0100: TIM8 BRK2 0101: TIM1 BRK2 + TIM8 BRK2 1100: TIM20 BRK or TIM20 BRK_ACTH ⁽⁴⁾ 1101: TIM20 BRK2 1110: TIM1 BRK2 + TIM8 BRK2 + TIM20 BRK2

Table 6. Comparator output connected internally to break inputs

- 1. Some newer STM32 series, such as STM32U5 abandoned the use of BRK_ACTH identifier using name system level or internal fault instead. The functionality remains analogous.
- 2. TIM1 BRK in case of COMP4 and COMP7, or TIM1 BRK_ACTH in case of COMPx, x = 1, 2, 3, 5, and 6.
- 3. TIM8 BRK in case of COMP4 and COMP7, or TIM8 BRK_ACTH in case of COMPx, x = 1, 2, 3, 5, and 6.
- 4. TIM20 BRK in case of COMP4 and COMP7, or TIM20 BRK_ACTH in case of COMPx, x= 1, 2, 3, 5, and 6.

On the contrary, the user may prefer to make use of the external error signal in conjunction with the internal one: the result is an OR between the two. Depending on the external comparator logic, the possible configurations to write are summarized in the following tables.

Table 7. Comparator output connected externally to break inputs, with low break polarity

Description	Register	Bit	Configuration
TIM1/8/20 BRK polarity	TIMx_BDTR	ВКР	0 (active low), it means that the external signal goes low during the fault
Comparator output polarity	COMPx_CSR	COMPxPOL	0 (not inverted), comparators input connected as shown in previous sections
TIM1/8/20 BKIN AF	GPIOxAFRL or GPIOxAFRH	-	AF enabled on BKIN pin selected among available
TIM1/8/20 BRK enable	TIMX_BDTR	BKE	1
COMPx out selection	COMPx_CSR	COMPxOUTSEL	0001: TIM1 BRK 0011: TIM8 BRK 1100: TIM20 BRK

Table 8. Comparator output connected externally to break inputs, with high break polarity

Description	Register	Bit	Configuration
TIM1/8/20 BRK/BRK2 polarity	TIMx_BDTR	BKP or BK2P	1 (active high), it means that the external signal goes high during the fault
Comparator output polarity	COMPx_CSR	COMPxPOL	0 (not inverted), comparators input connected as shown in previous sections
TIM1/8/20 BKIN/BKIN2 AF	GPIOxAFRL or GPIOxAFRH	-	AF enabled on BKIN/BKIN2 pin selected among available
TIM1/8/20 BRK/BRK2 enable	TIMX_BDTR	BKEor BK2E	1

AN4277 - Rev 7 page 18/26



D	escription	Register	Bit	Configuration
COMPx out	selection	COMPx_CSR	COMPxOUTSEL	0001: TIM1 BRK 0010: TIM1 BRK2 0011: TIM8 BRK 0100: TIM8 BRK2 0101: TIM1 BRK2 + TIM8 BRK2 1100: TIM20 BRK 1101: TIM20 BRK2 1110: TIM1 BRK2 + TIM8 BRK2 + TIM20 BRK2

The comparators output can be optionally enabled as an alternate function on the related GPIO pin, in push-pull or open-drain mode, for signaling to other devices or for debugging purposes.

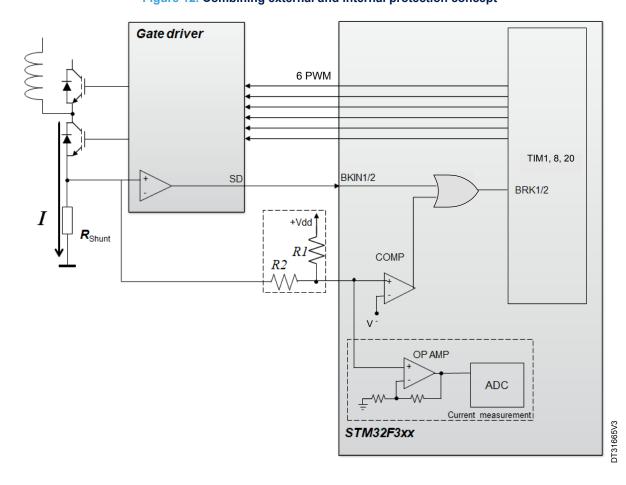


Figure 12. Combining external and internal protection concept

6.4 Filtering the break input

Programmable filters are available to prevent break functions of advanced timers from being triggered on spurious events (switching noise for instance).

The digital filter feature is available on BRK and BRK2. It is not available on BRK_ACTH. That means that the digital filter is:

- available when the break source is external and comes from the external inputs BKIN/BKIN2.
- available when the break source is internal and connected to BRK or BRK2.
- not available when the break source is internal and connected to BRK_ACTH.

AN4277 - Rev 7 page 19/26



6.5 Locking the selected configuration

Electrical motor drives require a high level of reliability and robustness for the potential damages that may be caused in case of failure.

To increase robustness against software runaways, the STM32F3 series microcontroller comes with a chain of peripherals featuring the lock feature, beginning from the mode of the GPIO pins used for sensing through comparators, operational amplifiers (OPAMP), and advanced timers, down to the GPIO pins used for driving, as shown in Figure 13.

In particular, BRK and BRK2 configurations can be locked using the LOCK bits in the TIMx_BDTR register. At least LOCK level 1 is recommended to freeze DTG/BKE/BKP/AOE/BKF/BK2F/BK2E/BK2P bits in the TIMx_BDTR register and OISx/OISxN bits in the TIMx_CR2 register until the next reset.

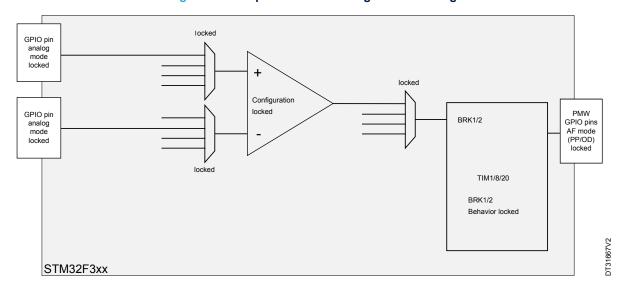


Figure 13. Comparator chain configuration locking

Table 9 summarizes the recommended settings for comparators.

Peripheral Feature Register Comment Inverting input, pin GPIOx MODER register, MODERy bit to GPIO port x, pin y mode selection be configured in analog mode Inverting input, pin GPIOx_LCKR register, specific write MODERy bit (in GPIOx_MODER GPIO port x, pin y configuration sequence coded with LCKy bit register) now frozen until next reset locking Non inverting input, GPIOw_MODER register, MODERz bit Not needed if an internal reference is GPIO port w, pin z pin mode selection to be configured in analog mode selected Non inverting input, MODERz bit (in the GPIOw_MODER GPIOw_LCKR register, specific write GPIO port w, pin z pin configuration sequence coded with LCKz bit register) now frozen until next reset locking LOCK level 1 (at least) recommended: BKIN/BKIN2 DTG bits in TIMx_BDTR register, OISx, TIMER 1/8/20 configuration TIMx_BDTR register, LOCK bits and OISxN bits in TIMx_CR2 register and BKE/BKP/AOE bits in TIMx_BDTR locking register frozen until next reset

Table 9. Register locking mechanism

AN4277 - Rev 7 page 20/26



Appendix A

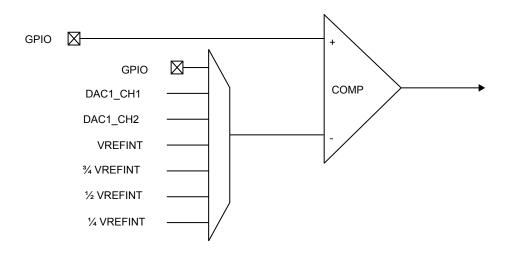
A.1 How to use the DAC to define thresholds

Concerning the network shown in Figure 10 and Figure 11, it is important to properly set the comparator inverting input voltage (V-) to define the threshold levels for overcurrent protection and overvoltage protection.

As shown in Figure 14 below, in the STM32F3 series microcontroller it is possible to set three different sources as inverting input for the comparator:

- An external reference (GPIO)
- A fixed internal reference (Vref, ³/₄ Vref, ¹/₂ Vref, ¹/₄ Vref)
- A programmable internal reference (DAC)

Figure 14. Inverting input selection



DT31663V1

Practical example: overcurrent protection using the offset network

This is the case of Figure 10 when the components inside the dotted line boxes are present. In this case, the formula to compute the overcurrent threshold is the following:

$$I_{th} = \frac{v^{-} - \left(v_{dd} \times \frac{R_2}{R_1 + R_2}\right)}{R_{Shunt} \times \left(\frac{R_1}{R_1 + R_2}\right)}$$

Usually the R_1 and R_2 values are used to satisfy the current measurement needs. It is clear that using the internal reference for V- can lead to a threshold value Ith, which is not exactly coincident with the required one. As explained in this practical example, the internal reference can be used only when there is no need to fine-tune the overcurrent threshold. Otherwise, it is necessary to use the external reference or the variable internal reference. The latter is recommended, because it does not require any external components.

The STM32F3 series microcontroller includes two 12-bit DAC channels that can be used for this purpose. For three-phase motor drives, it is possible to group three comparators to protect each leg of the inverter bridge versus overcurrent by setting the same DAC channel for all three inverter inputs.

The same can be done in case of dual-motor control with also having the possibility to define two different levels of protection, one for each motor.

AN4277 - Rev 7 page 21/26



Revision history

Table 10. Document revision history

Date	Revision	Changes
25-Nov-2013	1	Initial release.
05-Mar-2015	2	Updated cover page with STM32F3 series and adding RM references. Updated the whole document adding TIM20 and replacing STM32F30x/31 x by STM32F3 series. Updated Section 1: Break function overview adding Table 3: Peripherals availability per STM32 devices. Updated Figure 1: Break feature implementation for TIM1, TIM8, and TIM20. Updated Figure 11: Comparator chain configuration locking. Updated Table 9: Register locking mechanism.
30-Jun-2015	3	Updated Section 2.2: TIM15/16/17 break implementation removing the filter feature in BRK and BRK_ACTH paragraphs. Updated Figure 5: Break feature implementation for TIM15, TIM16, and TIM17 for STM32F1 series devices replacing filter/polarity by polarity. Updated Table 4: Break input sources adding "NA for TIM15/16/17" for 2 lines in BRK column.
03-May-2016	4	Updated cover page title and introduction with the application note applying to STM32 devices. Added Table 1: Applicable products. Updated Section 1: Break function overview. Added Table 2: Timers and break input availability in STM32 devices. Updated Table 3: Peripherals availability per STM32 devices. Updated Section 2: Break implementation. Updated Figure 1, Figure 2, Figure 3, Figure 5, Figure 6, and Figure 7. Updated Table 4: Break input sources. Updated Table 5: Scenarios of PWM output status in response to internal/external break events. Updated Section 5: Using the break function with other MCU resources adding a note. Updated Section: BRK_ATCH. Added Section: Bidirectional break inputs. Added Figure 4: Output redirection.
09-Mar-2022	5	Updated all document with STM32U series in: Section 1: General information Section 4: Break implementation Section 5: Break sources summary Section 7: Using the break function with other MCU resources Added: Figure 4: Break feature implementation in advanced timers for STM32U5 series devices Figure 9: Break feature implementation for TIM15, TIM16, and TIM17 in STM32U5 series devices
05-Jan-2023	6	Updated the whole document to add STM32 series information in: Section Table 1: Applicable products Section Table 3: Timers and break input availability in STM32 devices Section Table 4: Comparator peripherals availability per STM32 device Section 4.1: TIM1/8/20 break implementation Section 4.2: TIM15/16/17 break implementation Section 5: Break sources summary
06-Mar-2024	7	Added STM32U0 series. Updated: Document title Table 2. Timers and break input availability in STM32 devices Table 3. Comparator peripherals availability per STM32 device

AN4277 - Rev 7 page 22/26



Contents

1	Gen	eral information	2
2		ak function overview	
3	Brea	ak implementation	5
	3.1	TIM1/8/20 break implementation	5
	3.2	TIM15/16/17 break implementation	
4	Brea	ak sources summary	13
5	Exa	mples	14
6		ng the break function with other MCU resources	
	6.1	Break function used for overcurrent protection	16
	6.2	Break function used for overvoltage protection	17
	6.3	Using an external emergency signal together with the internal comparator	17
	6.4	Filtering the break input	19
	6.5	Locking the selected configuration	20
	A.1	How to use the DAC to define thresholds	21
Rev	ision	history	
Lis	t of ta	bles	24
Lis	t of fig	jures	25



List of tables

Table 1.	Applicable products	. 1
Table 2.	Timers and break input availability in STM32 devices	. 3
Table 3.	Comparator peripherals availability per STM32 device	. 4
Table 4.	Break input sources	13
Table 5.	Scenarios of PWM output status in response to internal/external break events	14
Table 6.	Comparator output connected internally to break inputs	18
Table 7.	Comparator output connected externally to break inputs, with low break polarity	18
Table 8.	Comparator output connected externally to break inputs, with high break polarity	18
Table 9.	Register locking mechanism	20
Table 10.	Document revision history	22

AN4277 - Rev 7 page 24/26



List of figures

Figure 1.	Break feature implementation in advanced timers for STM32F0/F1/F2/F4/F7 series devices	. 6
Figure 2.	Break feature implementation in advanced timers for STM32F3 series devices	
Figure 3.	Break feature implementation in advanced timers for STM32L4 series devices	. 8
Figure 4.	Break feature implementation in advanced timers for STM32U5 series devices	. 8
Figure 5.	Output redirection	. 9
Figure 6.	Break feature implementation for TIM15, TIM16, and TIM17 for STM32F1 series devices	10
Figure 7.	Break feature implementation for TIM15, TIM16, and TIM17 for STM32F3 series devices	11
Figure 8.	Break feature implementation for TIM15, TIM16, and TIM17 for STM32L4 and STM32H7 series devices	11
Figure 9.	Break feature implementation for TIM15, TIM16, and TIM17 in STM32U5 series devices	12
Figure 10.	Overcurrent protection network implemented with STM32F3 series devices	16
Figure 11.	Overvoltage protection network implemented with STM32F3 series devices	17
Figure 12.	Combining external and internal protection concept	19
Figure 13.	Comparator chain configuration locking	20
Figure 14.	Inverting input selection	21

AN4277 - Rev 7 page 25/26



IMPORTANT NOTICE - READ CAREFULLY

STMicroelectronics NV and its subsidiaries ("ST") reserve the right to make changes, corrections, enhancements, modifications, and improvements to ST products and/or to this document at any time without notice. Purchasers should obtain the latest relevant information on ST products before placing orders. ST products are sold pursuant to ST's terms and conditions of sale in place at the time of order acknowledgment.

Purchasers are solely responsible for the choice, selection, and use of ST products and ST assumes no liability for application assistance or the design of purchasers' products.

No license, express or implied, to any intellectual property right is granted by ST herein.

Resale of ST products with provisions different from the information set forth herein shall void any warranty granted by ST for such product.

ST and the ST logo are trademarks of ST. For additional information about ST trademarks, refer to www.st.com/trademarks. All other product or service names are the property of their respective owners.

Information in this document supersedes and replaces information previously supplied in any prior versions of this document.

© 2024 STMicroelectronics – All rights reserved

AN4277 - Rev 7 page 26/26